MA2SV02

Silicon epitaxial planar type

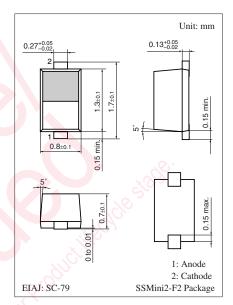
For VCO

■ Features

- \bullet Good linearity and large capacitance-ratio in $C_D V_R$ relation
- ullet Small series resistance r_D
- SS-Mini type package, allowing downsizing of equipment and automatic insertion through the taping package

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V _R	6	V	
Junction temperature	Tj	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	



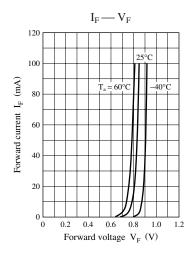
Marking Symbol: 3

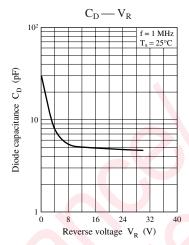
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

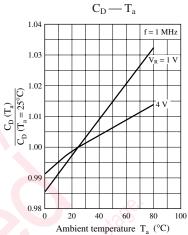
I_R	$V_R = 5 \text{ V}$	100	°O, .	10	A
~~()))				10	nA
$C_{D(1V)}$	$V_R = 1 \text{ V, } f = 1 \text{ MHz}$	18.0).	20.0	pF
C _{D(4V)}	$V_R = 4 \text{ V}, f = 1 \text{ MHz}$	7.3		9.0	
(1V) /C _{D(4V)}	612 0. 1100 100	2.1		2.6	_
r_{D}	$V_R = 4 \text{ V, f} = 470 \text{ MHz}$			0.3	Ω
_	V) /C _{D(4V)}	V) /C _{D(4V)}	$C_{\text{D(4V)}}$ $C_{\text{D(4V)}}$ $C_{\text{D(4V)}}$ $C_{\text{D(4V)}}$	$C_{D(4V)}$ $C_{D(4V)}$ $C_{D(4V)}$ $C_{D(4V)}$ $C_{D(4V)}$	$\frac{D(4V)}{V_0} / C_{D(4V)}$ 2.1 2.6

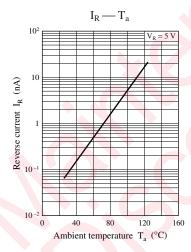
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. Absolute frequency of input and output is 470 MHz.
- 3. *: Measuring instrument; YHP MODEL 4191A RF IMPEDANCE ANALYZER









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2

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